

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Expedited Handling
Response under 37 CFR § 1.116

Appln. Ser. No.:	Filed:	Inventor(s):	Atty Dkt:
09/074,012	5 May 1998	S. Yoshida	114GI-121 (0694-121)
Title: Highly Heat-Conductive Composite Magnetic Body			
Examiner: B. Pianalto		Art Unit: 1762	

Box AF
Asst. Comm'r for Patents
Washington, D.C. 20231-00014 Pages Total in Response **VIA FACSIMILE**
703-872-9311

RESPONSE AND AMENDMENT

Official

Dear Sir:

FAX RECEIVED

In connection with the final rejection of the claims of this application mailed 7 December 2001, a Notice of Appeal having been filed on 7 June 2002, please first amend the subject application as follows, the amendments being shown in marked up form in the attached appendix.

IN THE CLAIMS:

sub } > 10. (Thrice amended.) An electronic device comprising:
a stationary electromagnetic interference suppressing body for suppressing electromagnetic interference due to external and/or internal presence of electromagnetic waves, said stationary electromagnetic interference suppressing body comprising an organic binding agent layer and a soft magnetic powder dispersed through said organic binding agent layer and further comprising a heat conductive powder dispersed through said organic binding agent layer, for improving the thermal conductivity of said electromagnetic interference suppressing body during use therein in association with said electronic device.

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